

**Features**

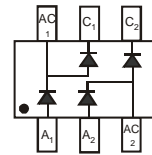
- Two Series Diode Circuits Connect to Form Full Wave Bridge
- Fast Switching Speed
- High Conductance
- High Reverse Breakdown Voltage Rating
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

**Mechanical Data**

- Case: SOT-26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Matte Tin Finish Annealed over Copper Leadframe (Lead-Free Plating). Solderable per MIL-STD-202, Method 208<sup>(E3)</sup>
- Polarity: See Diagram
- Weight: 0.016 grams (Approximate)



SOT-26  
TOP VIEW



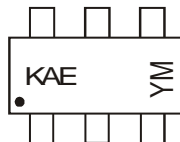
TOP VIEW  
Internal Schematic

**Ordering Information** (Note 4)

Part Number	Case	Packaging
MMBD3004BRM-7	SOT-26	3000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

**Marking Information**



KAE = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year ex: B = 2014  
 M = Month ex: 9 = September

Date Code Key

Year	2006	2007	...	2011	2012	2013	2014	2015	2016	2017	2018	2019
Code	T	U	...	Y	Z	A	B	C	D	E	F	G

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Maximum Ratings** (@ $T_A = +25^\circ\text{C}$  unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	$V_{RRM}$	350	V
Working Peak Reverse Voltage	$V_{RWM}$	300	V
DC Blocking Voltage	$V_R$		
RMS Reverse Voltage	$V_{R(RMS)}$	212	V
Forward Continuous Current (Note 5)	$I_F$	225	mA
Peak Repetitive Forward Current (Note 5)	$I_{FRM}$	625	mA
Non-Repetitive Peak Forward Surge Current	$I_{FSM}$	@ $t = 1.0\mu\text{s}$	4.0
		@ $t = 1.0\text{s}$	1.0

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	$P_D$	350	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{\theta JA}$	357	$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to +150	$^\circ\text{C}$

**Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$  unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	350	—	—	V	$I_R = 150\mu\text{A}$
Forward Voltage	$V_F$	—	0.78	0.87	V	$I_F = 20\text{mA}$ $I_F = 100\text{mA}$ $I_F = 200\text{mA}$
			0.93	1.0		
			1.03	1.25		
Reverse Current (Note 6)	$I_R$	—	30 35	100 100	nA $\mu\text{A}$	$V_R = 240\text{V}$ $V_R = 240\text{V}, T_J = +150^\circ\text{C}$
Total Capacitance	$C_T$	—	1.0	5.0	pF	$V_R = 0\text{V}, f = 1.0\text{MHz}$
Reverse Recovery Time	$t_{rr}$	—	—	50	ns	$I_F = I_R = 30\text{mA}$ , $I_{rr} = 3.0\text{mA}, R_L = 100\Omega$

- Notes:
- Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
  - Short duration pulse test used to minimize self-heating effect.

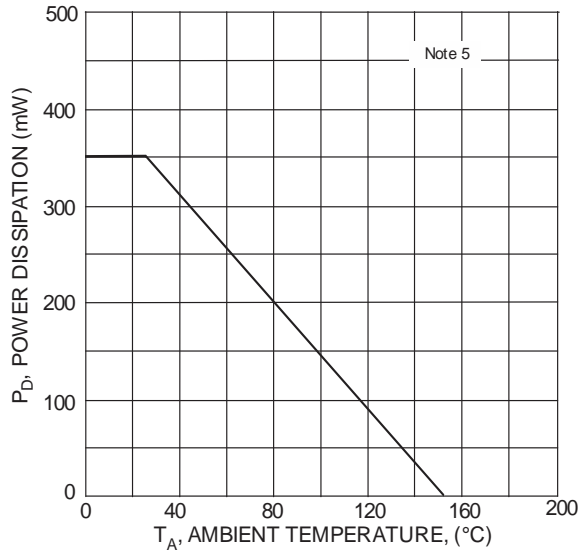


Fig. 1 Power Derating Curve, Total Package

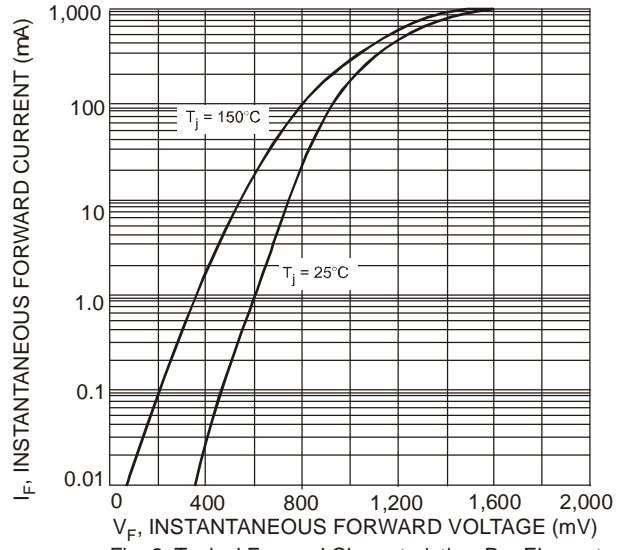


Fig. 2 Typical Forward Characteristics, Per Element

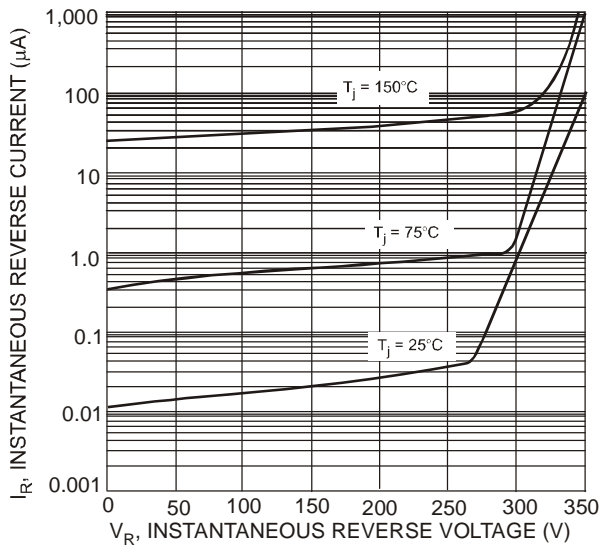


Fig. 3 Typical Reverse Characteristics, Per Element

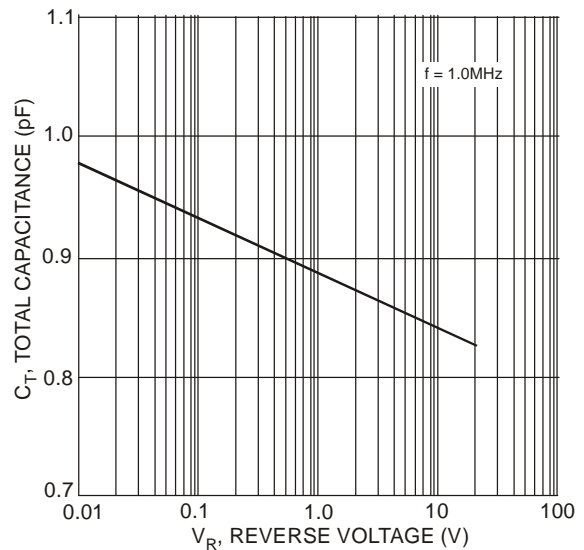
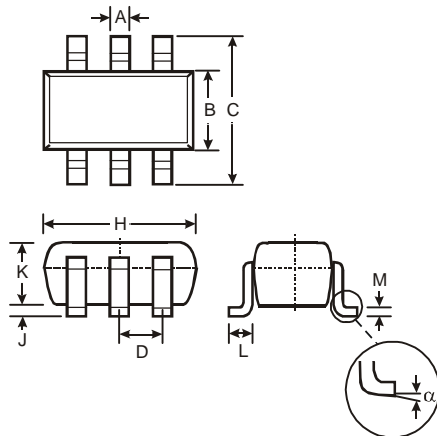


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

### Package Outline Dimensions

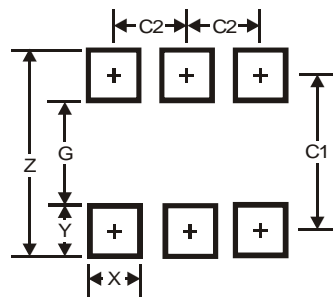
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



SOT26			
Dim	Min	Max	Typ
A	0.35	0.50	0.38
B	1.50	1.70	1.60
C	2.70	3.00	2.80
D	—	—	0.95
H	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
M	0.10	0.20	0.15
$\alpha$	0°	8°	—
All Dimensions in mm			

**Suggested Pad Layout**

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
Z	3.20
G	1.60
X	0.55
Y	0.80
C1	2.40
C2	0.95

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